

Special Section on Smart Multimedia & Communication Systems

The IEICE Transactions on Fundamentals of Electronics, Communications and Computer Sciences announces a forthcoming Special Section on Smart Multimedia & Communication Systems to be published in **December 2019**. The IEICE TC SIS conducted the 2018 International Workshop on Smart Info-Media Systems in Asia (SISA 2018) in order to enhance research activities on smart multimedia & communication fields in Asian countries. The objective of the special section is to review and promote recent progress in these research fields. The special section solicits paper submission particularly from, but not restricted to, researchers who presented their original works in SISA 2018.

Topics of interest include, but are not limited to:

Smart Wireless System	Cognitive Systems Intelligent	Soft-Wireless Systems
Intelligent Communication Systems	Multimedia over Wireless	OFDM Systems
CDMA Systems Intelligent	Mobile Systems	Near Field Communication
Speech Processing and Coding	Acoustic Signal Processing	Image/Video Processing and Coding
Image/Video Communications	Security Signal Processing	ITS Information Processing
Intelligent Multimedia Signal Processing		

Submission Guidelines:

Submit papers using the IEICE online submission web site https://review.ieice.org/regist/regist_baseinfo_e.aspx by **January 25**. Choose the “[Special-SM] Smart Multimedia & Communication Systems” as a “Journal/ Section” on the online submission page. We accept papers only in PDF format.

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Manuscripts should be prepared according to the style guidelines for the IEICE Transactions (See http://www.ieice.org/eng/shiori/mokuji_ess.html). In this special section, the length of the manuscript should be no longer than eight printed pages for a PAPER and two printed pages for a LETTER. Submissions that do not follow the above instructions will not be accepted. The term for revision after the review process might be shortened, although it is usually 60 days' long.

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